

## **Customer Information Notification**

Issue Date: 12-Feb-2020 Effective Date: 13-Feb-2020 Dear Tracy Hoglin,

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

This notice is NXP Company Proprietary.

## 2020010211



# QUALITY

Change Category				
[] Wafer Fab Process	[] Assembly	[] Product Marking	[] Test	[] Design
	Process		Location	
[] Wafer Fab Materials	[] Assembly	[] Mechanical Specification	n []Test	[] Errata
	Materials		Process	
[] Wafer Fab Location	[] Assembly	[]	[] Test	[] Electrical
	Location	Packing/Shipping/Labeling	Equipment	spec./Test coverage
[] Firmware	[X] Other - Dat	tasheet Updates		
MPC5777C Data Sheet				

### Description

NXP Semiconductors announces data sheet update for the MPC5777C from revision 13 to revision 14. The revision history included in the updated document provides a details description of the changes.

Data sheet changes:

Updates To Rev14

 Page 24: In Table 17, updated the footnote from "TUE does not apply to differential conversions" to "TUE, Gain, and Offset specifications do not apply to differential conversions".
Page 13: In Table 4, added Max value 120 uA for 40°C and 360 uA for 85°C for ISTBY.

The MPC5777C data sheet revision 14 is attached to this notice and can be found at: https://www.nxp.com/products/processors-and-microcontrollers/power-architecture-processors/mpc5xxx-55xx-32-bitmcus/ultra-reliable-mpc57xx-32-bit-automotive-and-industrial-microcontrollers-mcus/ultra-reliable-mpc5777c-mcu-forautomotive-industrial-engine-management:MPC5777C?tab=Documentation\_Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02 **Reason** The data sheet has been updated to provide additional technical clarification. **Identification of Affected Products** Product identification does not change

No impact on form, fit, function, reliability or quality. **Data Sheet Revision** A new datasheet will be issued Additional information Affected products and sales history information: see attached file Additional documents: view online

#### Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

View Notification	Subscription	Support
NXP   Privacy Policy   Terms of Use		

NXP Semiconductors

High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.

Affected Orderable Part#	Affected Part 12NC
SPC5777CCK3MME3	935315842557
SPC5777CK3MMO3	935318909557
SPC5777CK3MME3	935320923557
SPC5777CDK3MME3	935350948557
SPC5775BDK3MME2	935371593557
SPC5777CDK3MME4	935368231557
SPC5777CDK3MMO4	935368233557
SPC5775EDK3MME3	935370091557
SPC5777CDK3MMO3	935350951557